

EMP2-X402

mPCIe to Four RS422/485

Customer:

Customer

Part Number:

Innodisk

Part Number:

Innodisk

Model Name:

Date:

Innodisk	Customer
Approver	Approver

Table of Contents

- TABLE OF CONTENTS I**
- REVISION HISTORYII**
- LIST OF TABLES 1**
- LIST OF FIGURES 2**
- 1. PRODUCT INTRODUCTION 3**
 - 1.1. OVERVIEW 3
 - 1.2. FEATURES 3
- 2. PRODUCT SPECIFICATIONS 4**
 - 2.1. DEVICE PARAMETERS 4
 - 2.2. PERFORMANCE 4
 - 2.3. ELECTRICAL SPECIFICATIONS 5
 - 2.3.1.POWER REQUIREMENT 5
 - 2.3.2.POWER CONSUMPTION 5
 - 2.4. ENVIRONMENTAL SPECIFICATIONS 5
 - 2.4.1.TEMPERATURE RANGES 5
 - 2.4.2.HUMIDITY 5
 - 2.4.3.SHOCK AND VIBRATION 5
 - 2.4.4.MEAN TIME BETWEEN FAILURE (MTBF) 6
 - 2.5. CE AND FCC COMPATIBILITY 6
 - 2.6. ROHS COMPLIANCE 6
 - 2.7. HARDWARE..... 6
 - 2.7.1.LAYOUT 6
 - 2.7.2.PIN DEFINE 7
 - 2.7.3.I/O CONNECTOR MECHANICAL DRAWING & PIN DEFINES 8
 - 2.7.4.EMP2-X402 MECHANICAL DRAWING11
 - 2.7.5.CABLE MECHANICAL DRAWING & PIN DEFINES11
 - 2.7.6.PACKING LIST12
 - 2.8. SOFTWARE SUPPORT.....12
- 3. INSTALLATION GUIDE 12**
- 4. APPEDIX 13**
- CONTACT US..... 17**

REVISION HISTORY

Revision	Description	Date
1.0	First Released	Aug, 2018
1.1	mPCIe Pin Define 3.3V => 3.3V AUX	Mar, 2020
1.2	Correct DB9 pin out	Jun, 2020

List of Tables

TABLE 1: DEVICE PARAMETERS 4

TABLE 2: RS422/485 PERFORMANCE (UNIT: SECOND) 4

TABLE 3: POWER REQUIREMENT 5

TABLE 4: POWER CONSUMPTION 5

TABLE 5: TEMPERATURE RANGES 5

TABLE 6: SHOCK AND VIBRATION 5

TABLE 7: MEAN TIME BETWEEN FAILURE (MTBF)..... 6

TABLE 8: PCB LAYOUT LEGEND..... 7

TABLE 9: MPCIE PIN DEFINE 7

TABLE 10: WIRE TO BOARD SMD 2*5P CONNECTOR PIN DEFINE (CN1/CN2) 9

TABLE 11: PIN HEADER DIP 1*2P JUMPER SETTING (CN3/CN4/CN5/CN6) 9

TABLE 12: DB9 CABLE PIN DEFINE 12

List of Figures

- FIGURE 1: BLOCK DIAGRAM 3**
- FIGURE 2: PICTURE 4**
- FIGURE 3: WIRE TO BOARD SMD 2*5P CONNECTOR DRAWING (CN1/CN2) 8**
- FIGURE 4: PIN HEADER DIP 1*2P DRAWING (CN3/CN4/CN5/CN6)..... 9**
- FIGURE 5: DIP SWITCH 8PIN DRAWING (SW1)..... 10**
- FIGURE 6: EMP2-X402 DRAWING 11**
- FIGURE 7: DB9 CABLE DRAWING 11**

1. Product Introduction

1.1. Overview

Innodisk EMP2-X402 is designed with standard Mini PCI Express form factor, EMP2-X402 supports PCIe Gen 2.0 with a single lane to four independent UARTs RS422 & RS485, optimized for higher performance and lower power, which brings you a flexible expansion solution for embedded systems.

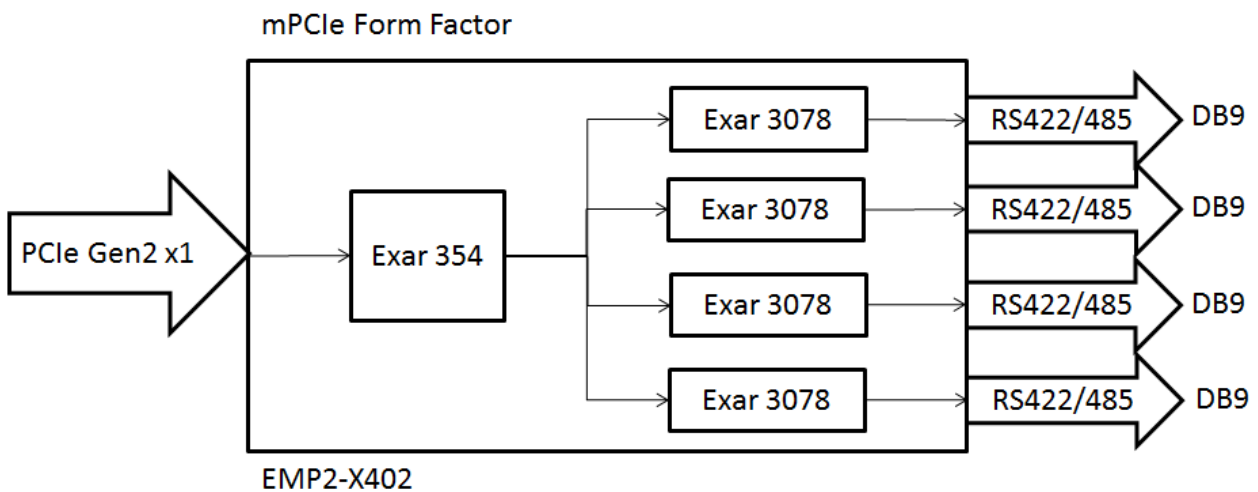


Figure 1: Block Diagram

1.2. Features

- PCIe 2.0 compliant. RS-422/485 mode configurable by switch. Supports 485HD(Half Duplex) and 485FD(Full Duplex)
- Up to 15 Mbps serial data rate. 16C550 compatible. 256-byte FIFOs
- Industrial temperature (-40 °C to 85 °C) operation.
- Flexible design with DB-9 connectors and cable.
- Termination Resistor by jumper setting.
- ESD up to 15KV (Electrostatic Discharge) protection circuit to prevent system damage.

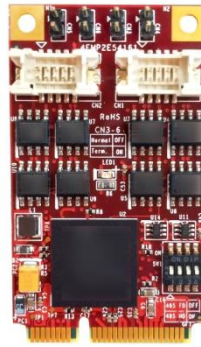


Figure 2: Picture

2. Product Specifications

2.1. Device Parameters

Table 1: Device Parameters

Form Factor	mPCIe
Input I/F	PCI Express 2.0 x 1
Output I/F	RS-422/485
Output Connector	DB-9 x 4
Dimension (WxLxH)	30 x 50.9 x 8.25 mm

2.2. Performance

Table 2: RS422/485 Performance (unit: second)

Baud Rate	Transmission Data Size	RS485 Half Duplex		RS485 Full Duplex (RS422)	
		100m	200m	100m	200m
9600	5Kbyte	5	5	5	5
	1Mbyte	1,267	1,267	1,267	1,267
115200	1Mbyte	106	106	106	106
460800	1Mbyte	26	26	28	27
921600	1Mbyte	13	13	13	14

2.3. Electrical Specifications

2.3.1. Power Requirement

Table 3: Power Requirement

Item	Connector	Rating
Input voltage	mPCIe Golden Finger	+3.3 DC +-5%

2.3.2. Power Consumption

Table 4: Power Consumption

Full Load (mA)	Voltage (V)
100	3.3

2.4. Environmental Specifications

2.4.1. Temperature Ranges

Table 5: Temperature Ranges

Temperature	Range
Operating	Industrial Grade: -40°C to +85°
Storage	-55°C to +95°

2.4.2. Humidity

Relative Humidity: 10-95%, non-condensing

2.4.3. Shock and Vibration

Table 6: Shock and Vibration

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 68-2-27

2.4.4. Mean Time between Failure (MTBF)

Reliability prediction methodology provides the basis for reliability evaluation and analysis. The purpose of the prediction is to predict the life time of the product in units of failure rate and MTBF.

Table 7: Mean Time between Failure (MTBF)

Product	Condition	MTBF (Hours)
EMP2-X402	The analysis is at 25°C ambient temperature by Telcordia SR-332, Issues 4, Method I, Case 3 under Ground Benign, Controlled environment, 50% operation stress	1,037,884

2.5. CE and FCC Compatibility

EMP2-X402 conforms to CE and FCC requirements.

2.6. RoHS Compliance

EMP2-X402 is fully compliant with RoHS directive.

2.7. Hardware

2.7.1. Layout

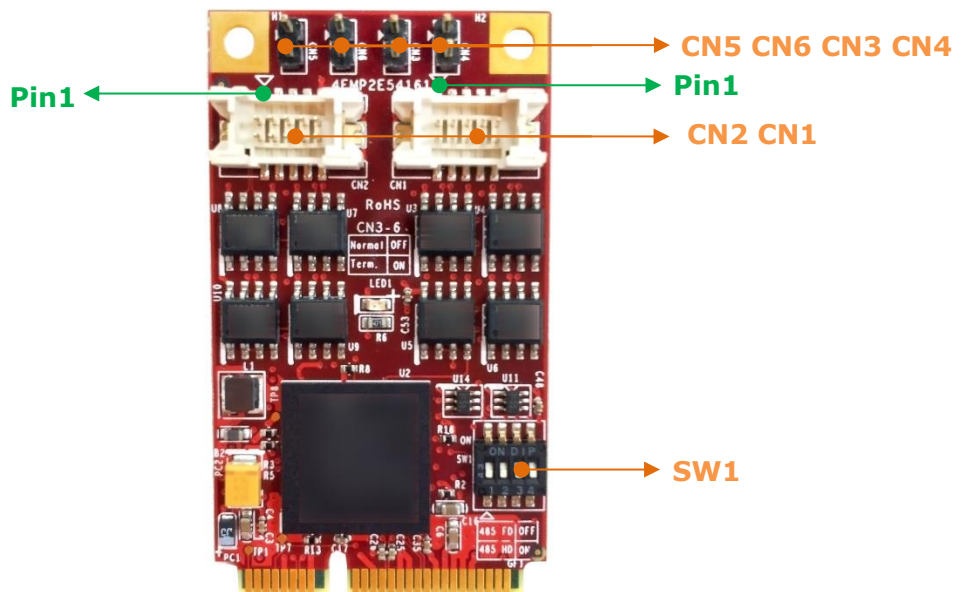


Table 8: PCB Layout Legend

Label	Connector Type	Function
CN1	Wire to board SMD 2*5P 180° P:1.25mm H:4.8mm	RS422/485 Port 1(red edge cable), 2
CN2	Wire to board SMD 2*5P 180° P:1.25mm H:4.8mm	RS422/485 Port 3(red edge cable), 4
CN3	Pin Header DIP 1*2P 180° P:2.0mm	Enable Termination Resistor of Port 1
CN4	Pin Header DIP 1*2P 180° P:2.0mm	Enable Termination Resistor of Port 2
CN5	Pin Header DIP 1*2P 180° P:2.0mm	Enable Termination Resistor of Port 3
CN6	Pin Header DIP 1*2P 180° P:2.0mm	Enable Termination Resistor of Port 4
SW1	DIP Switch, 8pin SMD 180°	RS422/485 Switch mode

2.7.2. Pin Define

Table 9: mPCIe Pin Define

Signal Name	Pin #	Pin #	Signal Name
NC	51	52	3.3V AUX
NC	49	50	GND
NC	47	48	NC
NC	45	46	NC
GND	43	44	NC
3.3V AUX	41	42	NC
3.3V AUX	39	40	GND
GND	37	38	NC
GND	35	36	NC
PERXP	33	34	GND

PERXN	31	32	NC
GND	29	30	NC
GND	27	28	NC
PETXP	25	26	GND
PETXN	23	24	3.3V AUX
GND	21	22	PERST#
NC	19	20	NC
NC	17	18	GND
GND	15	16	NC
REFCLK+	13	14	NC
REFCLK-	11	12	NC
GND	9	10	NC
CLKREQ#	7	8	NC
NC	5	6	NC
NC	3	4	GND
WAKE #	1	2	3.3V AUX

2.7.3. I/O Connector Mechanical Drawing & Pin Defines

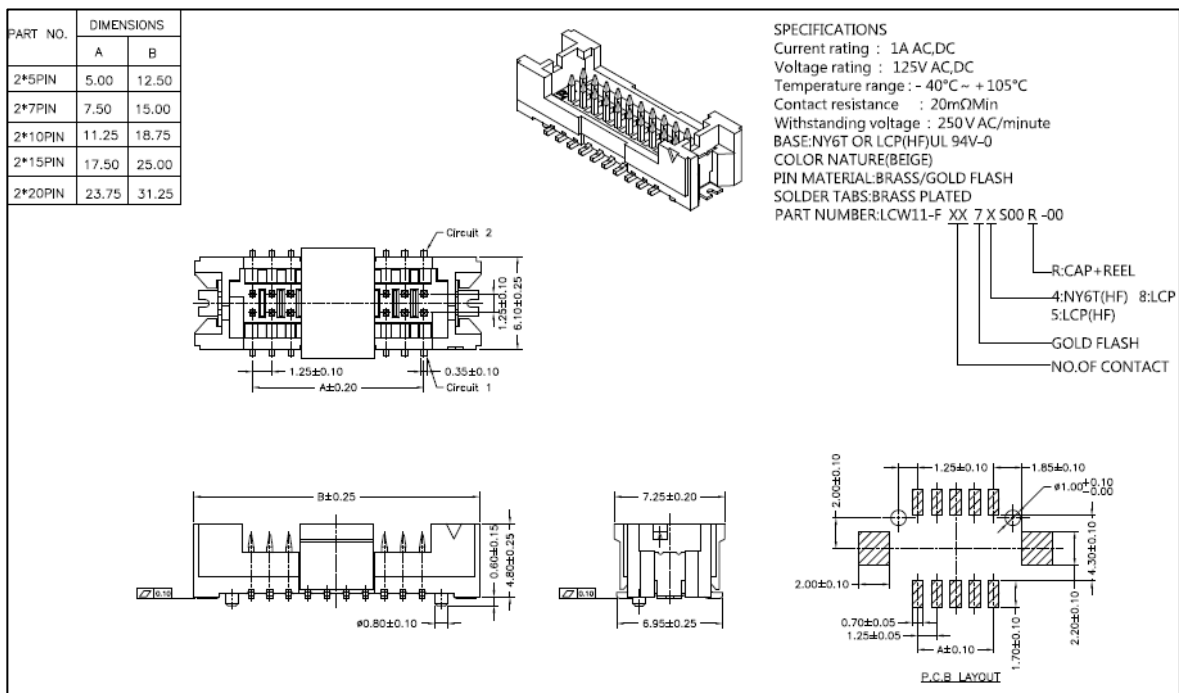


Figure 3: Wire to Board SMD 2*5P Connector Drawing (CN1/CN2)

Table 10: Wire to Board SMD 2*5P Connector Pin Define (CN1/CN2)

Signal Name	Pin #	Pin #	Signal Name
TX1- / D1-	2	1	TX0- / D0-
TX1+ / D1+	4	3	TX0+ / D0+
RX1+	6	5	RX0+
RX1-	8	7	RX0-
GND	10	9	GND

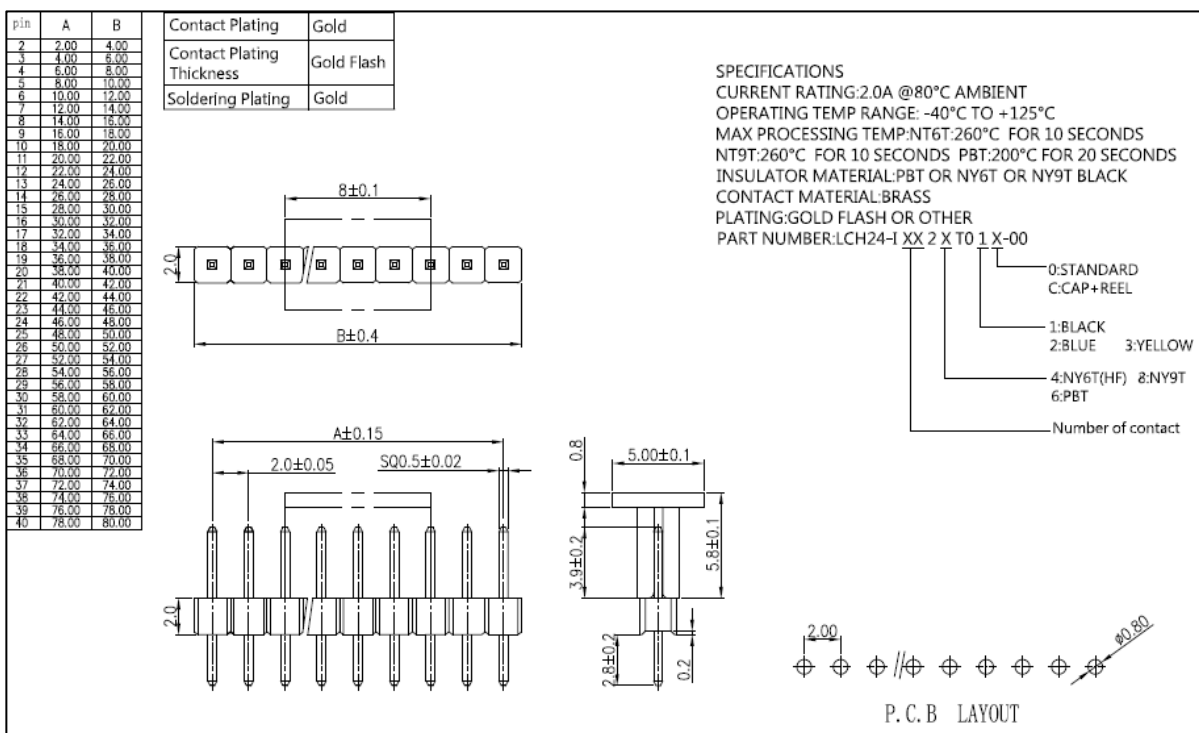


Figure 4: Pin Header DIP 1*2P Drawing (CN3/CN4/CN5/CN6)

Table 11: Pin Header DIP 1*2P Jumper Setting (CN3/CN4/CN5/CN6)

Jumper is set	Enable Termination Resistor
Jumper is NOT set	Disable Termination Resistor

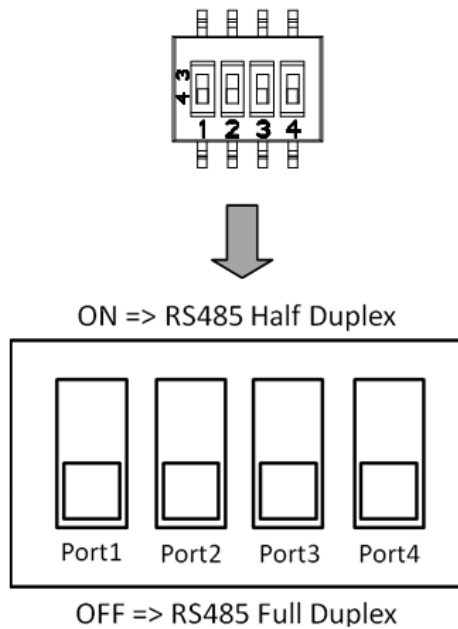
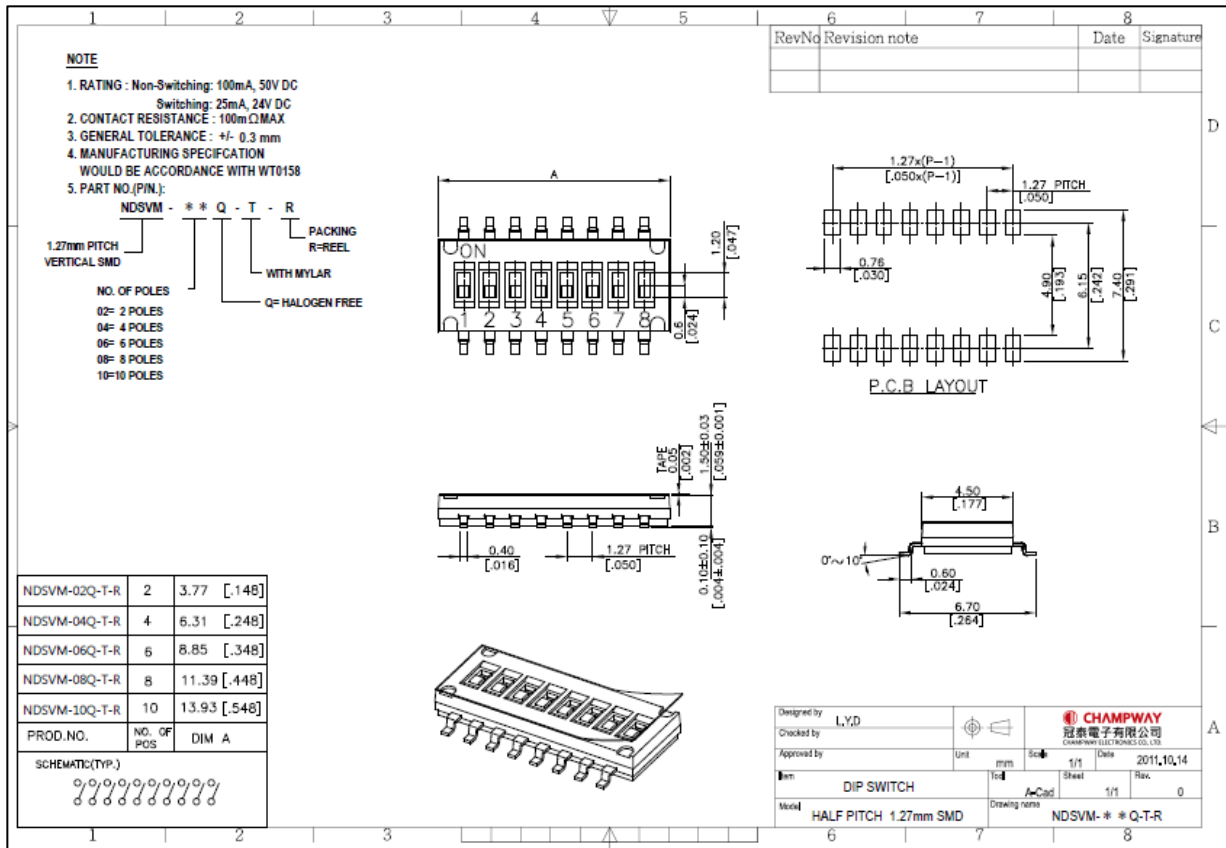


Figure 5: DIP Switch 8pin Drawing (SW1)

2.7.4. EMP2-X402 Mechanical Drawing

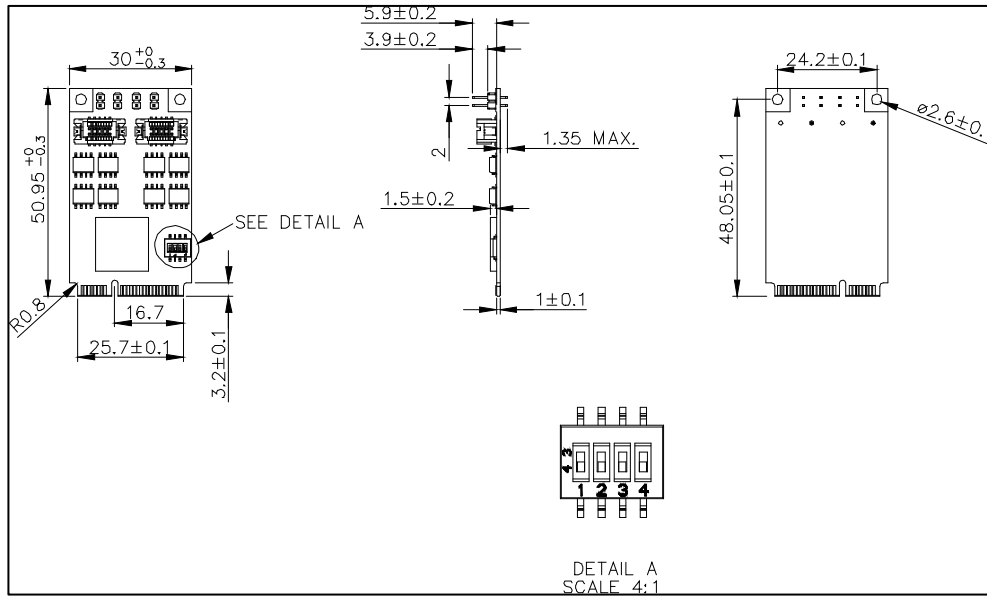


Figure 6: EMP2-X402 Drawing

2.7.5. Cable Mechanical Drawing & Pin Defines

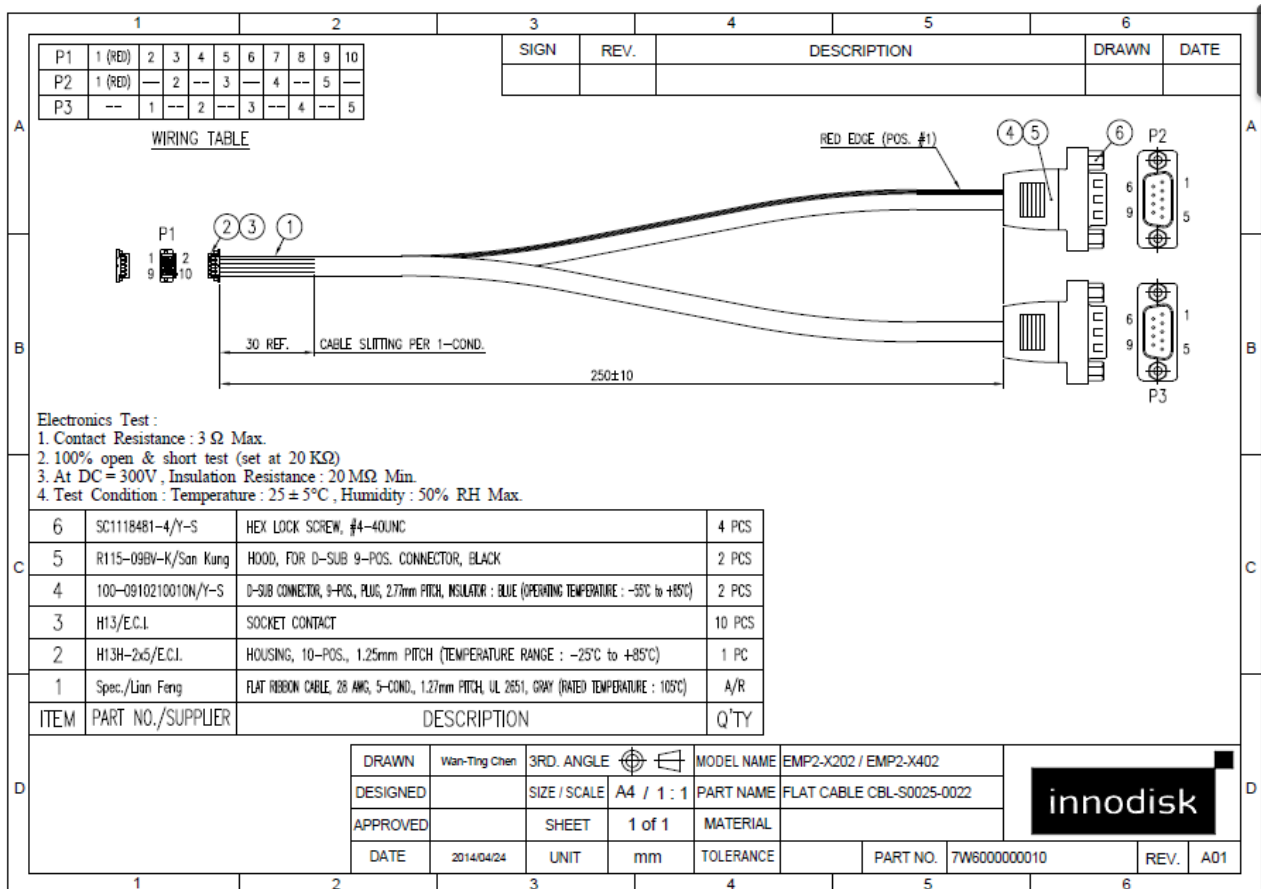


Figure 7: DB9 Cable Drawing

Table 12: DB9 Cable Pin Define

Pin #	Signal Name	
	Full duplex (RS422)	Half duplex (RS485)
1	TX-	D-
2	TX+	D+
3	RX+	NC
4	RX-	NC
5	GND	GND

2.7.6. Packing List

- EMP2-X402 x1
- DB9 Cable x2

2.8. Software Support

- Windows: XP, Windows 7, 8 , 8.1, 10, WES7, CE7.0
- Linux: Kernel 2.6.x and above.(Linux source code for modification)

3. Installation Guide

Please download driver and user manual from Myinnodisk web site.

<https://myinnodisk.innodisk.com/myinnodisk/Login.aspx>

4. Appedix

innodisk

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Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: <http://www.innodisk.com/>

REACH Declaration of Conformity

Manufacturer Product: All Innodisk EP products

1. 宜鼎國際股份有限公司（以下稱本公司）特此保證此售予貴公司之產品，皆符合歐盟化學品法案(Registration, Evaluation and Authorization of Chemicals; REACH)之規定

(<http://www.echa.europa.eu/de/candidate-list-table> last updated: 15/01/2018)。所提供之產品包含：(1) 產品或產品所使用到的所有原物料；(2) 包裝材料；(3) 設計、生產及重工過程中所使用到的所有原物料。

We Innodisk Corporation hereby declare that our products are in compliance with the requirements according to the REACH Regulation

(<http://www.echa.europa.eu/de/candidate-list-table> last updated: 15/01/2018).

Products include: 1) Product and raw material used by the product; 2) Packaging material; 3) Raw material used in the process of design, production and rework

2. 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。

InnoDisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

立保證書人 (Guarantor)

Company name 公司名稱：InnoDisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人：Randy Chien 簡川勝

Company Representative Title 公司代表人職稱：Chairman 董事長

Date 日期：2018/02/08



RoHS 自我宣告書 (RoHS Declaration of Conformity)

Manufacturer Product: All Innodisk EP products

- 一、 宜鼎國際股份有限公司（以下稱本公司）特此保證售予貴公司之所有產品，皆符合歐盟 2011/65/EU 及 (EU) 2015/863 關於 RoHS 之規範要求。

Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) and (EU) 2015/863 requirement.

- 二、 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。

Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
鉛 (Pb)	< 1000 ppm
汞 (Hg)	< 1000 ppm
鎘 (Cd)	< 100 ppm
六價鉻 (Cr 6+)	< 1000 ppm
多溴聯苯 (PBBs)	< 1000 ppm
多溴二苯醚 (PBDEs)	< 1000 ppm
鄰苯二甲酸二(2-乙基己基)酯 (DEHP)	< 1000 ppm
鄰苯二甲酸丁酯苯甲酯 (BBP)	< 1000 ppm
鄰苯二甲酸二丁酯 (DBP)	< 1000 ppm
鄰苯二甲酸二異丁酯 (DIBP)	< 1000 ppm

立 保 證 書 人 (Guarantor)

Company name 公司名稱： Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人： Randy Chien 簡川勝

Company Representative Title 公司代表人職稱： Chairman 董事長

Date 日期： 2018 / 02 / 08



Certificate

Issue Date: November 9, 2016
 Ref. Report No. ISL-16LE497CE

Product Name : mPCIe to four RS-422/485 module
 Model(s) : E%P2-X#02
 (%: Form factor: (2: 2.5"SSD, 3:DDR3 DIMM, D:Dongle,
 G:NGFF_M.2, H:mPCIe Half, L:PCIe Low profile, M:mPCIe, S:SATA,
 X:Multi, Z:Others)
 #: Output items: (1:1Port, 2:2Ports, 3:3Ports, 4:4Ports,
 A~Z:TBD,X:Multi))

Responsible Party : Innodisk Corporation
 Address : 5F., No.237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221, Taiwan (R.O.C.)

We, **International Standards Laboratory**, hereby certify that:

The device bearing the trade name and model specified above has been shown to comply with the applicable technical standards as indicated in the measurement report and was tested in accordance with the measurement procedures specified in European Council Directive- EMC Directive 2014/30/EU. The device was passed the test performed according to :



Standards:

EN 55032:2015 and CISPR 32:2015
 AS/NZS CISPR 32:2015
 EN 61000-3-2:2014 and IEC 61000-3-2:2014
 EN 61000-3-3: 2013 and IEC 61000-3-3: 2013
 EN 55024: 2010+A1:2015 and CISPR 24: 2010+A1:2015
 EN 61000-4-2: 2009 and IEC 61000-4-2: 2008
 EN 61000-4-3: 2006+A1: 2008 +A2: 2010 and
 IEC 61000-4-3:2006+A1: 2007+A2: 2010
 EN 61000-4-4:2012 and IEC 61000-4-4:2012

I attest to the accuracy of data and all measurements reported herein were performed by me or were made under my supervision and are correct to the best of my knowledge and belief. I assume full responsibility for the completeness of these measurements and vouch for the qualifications of all persons taking them.

International Standards Laboratory

W.H. Chang

W.H. Chang / Director

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Certificate

Issue Date: November 9, 2016
 Ref. Report No. ISL-16LE497FB

Product Name : mPCIe to four RS-422/485 module
 Model(s) : E%P2-X#02
 (%: Form factor: (2: 2.5"SSD, 3:DDR3 DIMM, D:Dongle,
 G:NGFF_M.2, H:mPCIe Half, L:PCIe Low profile, M:mPCIe, S:SATA,
 X:Multi, Z:Others)
 #: Output items: (1:1Port, 2:2Ports, 3:3Ports, 4:4Ports,
 A~Z:TBD,X:Multi))

Applicant : Innodisk Corporation
 Address : 5F., No.237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221, Taiwan (R.O.C.)

We, **International Standards Laboratory**, hereby certify that:

The device bearing the trade name and model specified above has been shown to comply with the applicable technical standards as indicated in the measurement report and was tested in accordance with the measurement procedures specified. (refer to Test Report if any modifications were made for compliance).



Standards:

FCC CFR Title 47 Part 15 Subpart B: 2015- Section 15.107 and 15.109
 ANSI C63.4-2014
 Industry Canada Interference-Causing Equipment Standard ICES-003 Issue 6: 2016
Class B

I attest to the accuracy of data and all measurements reported herein were performed by me or were made under my supervision and are correct to the best of my knowledge and belief. I assume full responsibility for the completeness of these measurements and vouch for the qualifications of all persons taking them.

International Standards Laboratory

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June 24, 2020